ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC. Bannockl	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances w all lower	vithin the manufactu level materials for v	rer listed	item. Note: nanufacture	if the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					ion				
Supplier Information														
Company name*			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2025-00	2025-06-07			
ontact Name Title - Contact			ct	T I I I I I I I I I I I I I I I I I I I			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Re			- Representative			Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date Version Manufacturing Sit		lanufacturing Site		Weight*	UOM	Unit Type		
	FAN533	V5333ASX DC/DC Boost LE		ED Driver	Driver 2			PI	PBB		17.213	mg	Each	
Ianufacturing Proccess Informa	ation							<u>_</u>						
Terminal Plating / Grid Array M	Iaterial 7	Ferminal Base	lloy J-STD-020 MSL Rati		Rating	Peak Proce	ocess Body Temperature Max Tim		e Max Time at Peal	ak Temperature Number		ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU A		CU Alloy	1			260	260 C		30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.46	mg	Supplier	Silicon (Si)	7440-21-3		0.46	mg
Die Attach	0.23	mg		Bismaleimide Resin	proprietary data		0.038	mg
			Supplier	Other Additive Agents	Proprietary Data		0.0081	mg
			Supplier	Silver (Ag)	7440-22-4		0.184	mg
Lead Frame	7.29	mg	Supplier	Silver (Ag)	7440-22-4		0.0146	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0087	mg
			Supplier	Iron (Fe)	7439-89-6		0.1713	mg
			Supplier	Copper (Cu)	7440-50-8		7.0932	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0022	mg
Mold Compound-Black	8.68	mg	Supplier	Zinc borate	1332-07-6		0.3038	mg
			Supplier	Phenol, polymer with 1,4- bis(methoxymethyl)benzene	26834-02-6		0.3472	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.868	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0434	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7.1176	mg
Plating	0.453	mg	Supplier	Tin (Sn)	7440-31-5		0.453	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg